IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Box: Patent Applications

Jun HATAKEYAMA et al.

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Serial No.: Not Yet Assigned

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Filed: April 26, 2001

POLYMER, CHEMICALLY AMPLIFIED RESIST COMPOSITION AND

PATTERNING PROCESS

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

For:

Prior to calculating the filing fee and examination of the above-identified application, please amend this application, as follows:

IN THE CLAIMS:

Please amend claims 3 and 4 as follows:

- 3. (Amended) A chemically amplified resist composition comprising the polymer of claim 1.
 - 4. (Amended) A chemically amplified positive resist composition comprising
 - (A) the polymer of claim 1,
 - (B) an organic solvent, and
 - (C) a photoacid generator.

REMARKS

The purpose of this preliminary amendment is to eliminate the multiple dependency of the claims in order to avoid the additional fee.

Attached hereto is a marked-up version of the changes made to claims 3 and 4 by the current amendment. The attached page is captioned "Version with markings to show changes made."

Respectfully submitted,

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Filed: April 25, 2001

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VERSION WITH MARKINGS TO SHOW CHANGES MADE

Claims 3 and 4 have been amended as follows:

- 3. (Amended) A chemically amplified resist composition comprising the polymer of claim 1 or 2.
 - 4. (Amended) A chemically amplified positive resist composition comprising
 - (A) the polymer of claim 1 or 2,
 - (B) an organic solvent, and
 - (C) a photoacid generator.